

## List of Publications by Citations

**Source:** <https://exaly.com/author-pdf/4231727/amauri-garcia-publications-by-citations.pdf>  
**Version:** 2024-04-10

This document has been generated based on the publications and citations recorded by exaly.com. For the latest version of this publication list, visit the link given above.  
The third column is the impact factor (IF) of the journal, and the fourth column is the number of citations of the article.

357 papers	8,071 citations	49 h-index	68 g-index
370 ext. papers	8,972 ext. citations	3.6 avg, IF	6.27 L-index

#	Paper	IF	Citations
357	Correlation between unsteady-state solidification conditions, dendrite spacings, and mechanical properties of Al-Cu alloys. <i>Metallurgical and Materials Transactions A: Physical Metallurgy and Materials Science</i> , <b>2000</b> , 31, 3167-3178	2.3	145
356	Determination of transient interfacial heat transfer coefficients in chill mold castings. <i>Journal of Alloys and Compounds</i> , <b>2001</b> , 319, 174-186	5.7	142
355	Effects of Zr content on microstructure and corrosion resistance of TiâB0NbâZr casting alloys for biomedical applications. <i>Electrochimica Acta</i> , <b>2008</b> , 53, 2809-2817	6.7	136
354	Microstructure and mechanical properties of SnâBi, SnâAg and SnâZn lead-free solder alloys. <i>Journal of Alloys and Compounds</i> , <b>2013</b> , 572, 97-106	5.7	135
353	Heat flow parameters affecting dendrite spacings during unsteady-state solidification of Sn-Pb and Al-Cu alloys. <i>Metallurgical and Materials Transactions A: Physical Metallurgy and Materials Science</i> , <b>2003</b> , 34, 995-1006	2.3	125
352	Effect of dendritic arm spacing on mechanical properties and corrosion resistance of Al 9 Wt Pct Si and Zn 27 Wt Pct Al alloys. <i>Metallurgical and Materials Transactions A: Physical Metallurgy and Materials Science</i> , <b>2006</b> , 37, 2525-2538	2.3	117
351	Electrochemical corrosion behavior of a TiâB5Nb alloy for medical prostheses. <i>Electrochimica Acta</i> , <b>2008</b> , 53, 4867-4874	6.7	115
350	Macrostructural and microstructural development in AlâBi alloys directionally solidified under unsteady-state conditions. <i>Journal of Alloys and Compounds</i> , <b>2004</b> , 381, 168-181	5.7	110
349	Modeling dendritic structure and mechanical properties of ZnâAl alloys as a function of solidification conditions. <i>Materials Science &amp; Engineering A: Structural Materials: Properties, Microstructure and Processing</i> , <b>2002</b> , 325, 103-111	5.3	107
348	Solidification thermal parameters affecting the columnar-to-equiaxed transition. <i>Metallurgical and Materials Transactions A: Physical Metallurgy and Materials Science</i> , <b>2002</b> , 33, 2107-2118	2.3	103
347	Electrochemical behavior of centrifuged cast and heat treated TiâCu alloys for medical applications. <i>Electrochimica Acta</i> , <b>2010</b> , 55, 759-770	6.7	102
346	Mathematical modeling and optimization strategies (genetic algorithm and knowledge base) applied to the continuous casting of steel. <i>Engineering Applications of Artificial Intelligence</i> , <b>2003</b> , 16, 511-527	7.2	97
345	The role of macrostructural morphology and grain size on the corrosion resistance of Zn and Al castings. <i>Materials Science &amp; Engineering A: Structural Materials: Properties, Microstructure and Processing</i> , <b>2005</b> , 402, 22-32	5.3	91
344	The roles of macrosegregation and of dendritic array spacings on the electrochemical behavior of an Alâ4.5wt.% Cu alloy. <i>Electrochimica Acta</i> , <b>2007</b> , 52, 3265-3273	6.7	89
343	Mechanical properties of SnâZn lead-free solder alloys based on the microstructure array. <i>Materials Characterization</i> , <b>2010</b> , 61, 212-220	3.9	88
342	The effect of the dendritic microstructure on the corrosion resistance of ZnâAl alloys. <i>Journal of Alloys and Compounds</i> , <b>2005</b> , 397, 179-191	5.7	88
341	Mechanical properties as a function of microstructure and solidification thermal variables of AlâBi castings. <i>Materials Science &amp; Engineering A: Structural Materials: Properties, Microstructure and Processing</i> , <b>2006</b> , 421, 245-253	5.3	86

340	Cellular growth during transient directional solidification of hypoeutectic Al-Fe alloys. <i>Journal of Alloys and Compounds</i> , <b>2009</b> , 470, 589-599	5.7	77
339	Influence of melt convection on the columnar to equiaxed transition and microstructure of downward unsteady-state directionally solidified Sn-Pb alloys. <i>Journal of Alloys and Compounds</i> , <b>2004</b> , 384, 217-226	5.7	76
338	Effects of eutectic modification and T4 heat treatment on mechanical properties and corrosion resistance of an Al-9 wt%Si casting alloy. <i>Materials Chemistry and Physics</i> , <b>2007</b> , 106, 343-349	4.4	72
337	Microstructure, corrosion behaviour and microhardness of a directionally solidified Sn-Cu solder alloy. <i>Electrochimica Acta</i> , <b>2011</b> , 56, 8891-8899	6.7	71
336	Microstructural and hardness investigation of an aluminum-copper alloy processed by laser surface melting. <i>Materials Characterization</i> , <b>2003</b> , 50, 249-253	3.9	70
335	The effects of cell spacing and distribution of intermetallic fibers on the mechanical properties of hypoeutectic Al-Fe alloys. <i>Materials Chemistry and Physics</i> , <b>2010</b> , 119, 272-278	4.4	69
334	Dendritic Arm Spacing Affecting Mechanical Properties and Wear Behavior of Al-Sn and Al-Si Alloys Directionally Solidified under Unsteady-State Conditions. <i>Metallurgical and Materials Transactions A: Physical Metallurgy and Materials Science</i> , <b>2010</b> , 41, 972-984	2.3	68
333	Mechanical properties of Sn-Ag lead-free solder alloys based on the dendritic array and Ag <sub>3</sub> Sn morphology. <i>Journal of Alloys and Compounds</i> , <b>2013</b> , 562, 194-204	5.7	67
332	Effect of silicon content on microstructure and electrochemical behavior of hypoeutectic Al-Si alloys. <i>Materials Letters</i> , <b>2008</b> , 62, 365-369	3.3	64
331	Modeling of solidification in twin-roll strip casting. <i>Journal of Materials Processing Technology</i> , <b>2000</b> , 102, 33-39	5.3	64
330	Microstructural development during transient directional solidification of hypermonotectic Al-Bi alloys. <i>Materials &amp; Design</i> , <b>2010</b> , 31, 4584-4591		63
329	Cellular/Dendritic Transition and Microstructure Evolution during Transient Directional Solidification of Pb-Sb Alloys. <i>Metallurgical and Materials Transactions A: Physical Metallurgy and Materials Science</i> , <b>2008</b> , 39, 2161-2174	2.3	62
328	Interfacial heat transfer coefficients and solidification of an aluminum alloy in a rotary continuous caster. <i>International Journal of Heat and Mass Transfer</i> , <b>2009</b> , 52, 451-459	4.9	61
327	Corrosion resistance of directionally solidified Al-Cu-Si and Al-Cu-Bi alloys castings. <i>Materials &amp; Design</i> , <b>2011</b> , 32, 3832-3837		61
326	Electrochemical corrosion response of a low carbon heat treated steel in a NaCl solution. <i>Materials and Corrosion - Werkstoffe Und Korrosion</i> , <b>2009</b> , 60, 804-812	1.6	59
325	Cellular/dendritic transition during unsteady-state unidirectional solidification of Sn-Pb alloys. <i>Materials Science &amp; Engineering A: Structural Materials: Properties, Microstructure and Processing</i> , <b>2003</b> , 347, 59-69	5.3	59
324	The columnar to equiaxed transition during solidification of Sn-Pb alloys. <i>Journal of Alloys and Compounds</i> , <b>2003</b> , 351, 126-134	5.7	59
323	The effect of cooling rate on the dendritic spacing and morphology of Ag <sub>3</sub> Sn intermetallic particles of a SnAg solder alloy. <i>Materials &amp; Design</i> , <b>2011</b> , 32, 3008-3012		57

322	The effect of melt temperature profile on the transient metal/mold heat transfer coefficient during solidification. <i>Materials Science &amp; Engineering A: Structural Materials: Properties, Microstructure and Processing</i> , <b>2005</b> , 408, 317-325	5.3	57
321	Effect of solution time in T6 heat treatment on microstructure and hardness of a directionally solidified Al <sub>85</sub> Si <sub>15</sub> alloy. <i>Journal of Alloys and Compounds</i> , <b>2016</b> , 683, 485-494	5.7	57
320	Cellular spacings in unsteady-state directionally solidified Sn <sub>80</sub> Pb <sub>20</sub> alloys. <i>Materials Science &amp; Engineering A: Structural Materials: Properties, Microstructure and Processing</i> , <b>2003</b> , 361, 111-118	5.3	56
319	The correlation between dendritic microstructure and mechanical properties of directionally solidified hypoeutectic Al-Ni alloys. <i>Metals and Materials International</i> , <b>2010</b> , 16, 39-49	2.4	55
318	Secondary dendrite arm spacing and solute redistribution effects on the corrosion resistance of Al <sub>90</sub> Sn <sub>10</sub> wt% and Al <sub>90</sub> Zn <sub>10</sub> wt% Zn alloys. <i>Materials Science &amp; Engineering A: Structural Materials: Properties, Microstructure and Processing</i> , <b>2006</b> , 420, 179-186	5.3	54
317	EIS and potentiodynamic polarization studies on immiscible monotectic Al <sub>85</sub> Hg <sub>15</sub> alloys. <i>Electrochimica Acta</i> , <b>2013</b> , 102, 436-445	6.7	53
316	Mechanical properties as a function of thermal parameters and microstructure of Zn <sub>55</sub> Al <sub>45</sub> castings. <i>Journal of Materials Processing Technology</i> , <b>2003</b> , 143-144, 703-709	5.3	53
315	Electrochemical corrosion characterization of Al <sub>85</sub> Ni <sub>15</sub> alloys in a dilute sodium chloride solution. <i>Electrochimica Acta</i> , <b>2010</b> , 55, 4078-4085	6.7	52
314	Influence of melt convection on dendritic spacings of downward unsteady-state directionally solidified Al <sub>85</sub> Cu <sub>15</sub> alloys. <i>Materials Science &amp; Engineering A: Structural Materials: Properties, Microstructure and Processing</i> , <b>2004</b> , 383, 271-282	5.3	52
313	Mathematical model for the unidirectional solidification of metals: II. Massive molds. <i>Metallurgical and Materials Transactions B - Process Metallurgy and Materials Processing Science</i> , <b>1979</b> , 10, 85-92		52
312	Microstructural evolution during upward and downward transient directional solidification of hypomonotectic and monotectic Al <sub>85</sub> Bi <sub>15</sub> alloys. <i>Journal of Alloys and Compounds</i> , <b>2009</b> , 480, 485-493	5.7	51
311	Mathematical model for the unidirectional solidification of metals: I. cooled molds. <i>Metallurgical and Materials Transactions B - Process Metallurgy and Materials Processing Science</i> , <b>1978</b> , 9, 449-457		50
310	Design of mechanical properties of a Zn <sub>27</sub> Al alloy based on microstructure dendritic array spacing. <i>Materials &amp; Design</i> , <b>2007</b> , 28, 2425-2430		49
309	The roles of cellular and dendritic microstructural morphologies on the corrosion resistance of Pb <sub>80</sub> Sb <sub>20</sub> alloys for lead acid battery grids. <i>Journal of Power Sources</i> , <b>2008</b> , 175, 595-603	8.9	49
308	The use of artificial intelligence technique for the optimisation of process parameters used in the continuous casting of steel. <i>Applied Mathematical Modelling</i> , <b>2002</b> , 26, 1077-1092	4.5	49
307	Numerical modeling and optimization of zone refining. <i>Journal of Alloys and Compounds</i> , <b>2000</b> , 298, 299-305	3.95	49
306	Dendritic solidification microstructure affecting mechanical and corrosion properties of a Zn <sub>40</sub> Al alloy. <i>Journal of Materials Science</i> , <b>2005</b> , 40, 4493-4499	4.3	47
305	The use of a heuristic search technique for the optimization of quality of steel billets produced by continuous casting. <i>Engineering Applications of Artificial Intelligence</i> , <b>2001</b> , 14, 229-238	7.2	47

304	Tensile properties and related microstructural aspects of hypereutectic Al-Si alloys directionally solidified under different melt superheats and transient heat flow conditions. <i>Materials Science &amp; Engineering A: Structural Materials: Properties, Microstructure and Processing</i> , <b>2017</b> , 685, 235-243	5.3	46
303	Cellular/dendritic arrays and intermetallic phases affecting corrosion and mechanical resistances of an Al-Mg-Bi alloy. <i>Journal of Alloys and Compounds</i> , <b>2016</b> , 673, 220-230	5.7	46
302	Electrochemical behavior of a lead-free SnAg solder alloy affected by the microstructure array. <i>Materials &amp; Design</i> , <b>2011</b> , 32, 4763-4772		46
301	The effects of a eutectic modifier on microstructure and surface corrosion behavior of Al-Si hypoeutectic alloys. <i>Journal of Solid State Electrochemistry</i> , <b>2007</b> , 11, 1421-1427	2.6	46
300	Microstructural Development in Al-Ni Alloys Directionally Solidified under Unsteady-State Conditions. <i>Metallurgical and Materials Transactions A: Physical Metallurgy and Materials Science</i> , <b>2008</b> , 39, 1712-1726	2.3	46
299	Electrochemical behavior of a lead-free Sn-Cu solder alloy in NaCl solution. <i>Corrosion Science</i> , <b>2014</b> , 80, 71-81	6.8	45
298	Macrosegregation and microstructure dendritic array affecting the electrochemical behaviour of ternary Al-Cu-Bi alloys. <i>Electrochimica Acta</i> , <b>2011</b> , 56, 8412-8421	6.7	45
297	Design of mechanical properties of Al-alloys chill castings based on the metal/mold interfacial heat transfer coefficient. <i>International Journal of Thermal Sciences</i> , <b>2012</b> , 51, 145-154	4.1	44
296	Numerical and experimental investigation of microporosity formation in a ternary Al-Cu-Bi alloy. <i>Journal of Alloys and Compounds</i> , <b>2010</b> , 503, 31-39	5.7	44
295	Wetting Behavior and Mechanical Properties of Sn-Zn and Sn-Pb Solder Alloys. <i>Journal of Electronic Materials</i> , <b>2009</b> , 38, 2405-2414	1.9	44
294	Relationship between spacing of eutectic colonies and tensile properties of transient directionally solidified Al-Ni eutectic alloy. <i>Journal of Alloys and Compounds</i> , <b>2018</b> , 733, 59-68	5.7	43
293	The role of Cu-based intermetallics on the pitting corrosion behavior of Sn-Cu, Ti-Cu and Al-Cu alloys. <i>Electrochimica Acta</i> , <b>2012</b> , 77, 189-197	6.7	43
292	Analytical, numerical, and experimental analysis of inverse macrosegregation during upward unidirectional solidification of Al-Cu alloys. <i>Metallurgical and Materials Transactions B: Process Metallurgy and Materials Processing Science</i> , <b>2004</b> , 35, 285-297	2.5	43
291	The effect of solidification variables on tertiary dendrite arm spacing in unsteady-state directional solidification of Sn-Pb and Al-Cu alloys. <i>Materials Science &amp; Engineering A: Structural Materials: Properties, Microstructure and Processing</i> , <b>2004</b> , 373, 131-138	5.3	43
290	Electrochemical corrosion parameters of as-cast Al-Fe alloys in a NaCl solution. <i>Corrosion Science</i> , <b>2010</b> , 52, 2979-2993	6.8	42
289	Microstructure, tensile properties and wear resistance correlations on directionally solidified Al-Sn-(Cu; Si) alloys. <i>Journal of Alloys and Compounds</i> , <b>2017</b> , 695, 3621-3631	5.7	41
288	Effects of cell size and macrosegregation on the corrosion behavior of a dilute Pb-Bi alloy. <i>Journal of Power Sources</i> , <b>2006</b> , 162, 696-705	8.9	40
287	Cooling thermal parameters, microstructure, segregation and hardness in directionally solidified Al-Bi-(Si;Cu) alloys. <i>Materials &amp; Design</i> , <b>2015</b> , 72, 31-42		39

286	Alloy composition and metal/mold heat transfer efficiency affecting inverse segregation and porosity of as-cast Al <sub>80</sub> Cu <sub>20</sub> alloys. <i>Materials &amp; Design</i> , <b>2009</b> , 30, 2090-2098		39
285	High cooling rate cells, dendrites, microstructural spacings and microhardness in a directionally solidified Al <sub>80</sub> Mg <sub>20</sub> Bi alloy. <i>Journal of Alloys and Compounds</i> , <b>2015</b> , 636, 145-149	5.7	38
284	Microstructure and electrochemical corrosion behavior of a Pb <sub>90</sub> Sn <sub>10</sub> alloy for lead-acid battery components. <i>Journal of Power Sources</i> , <b>2009</b> , 192, 724-729	8.9	38
283	Cellular to dendritic transition during transient solidification of a eutectic Sn <sub>60.7</sub> Cu <sub>39.3</sub> solder alloy. <i>Materials Chemistry and Physics</i> , <b>2012</b> , 132, 203-209	4.4	37
282	Thermal Parameters, Microstructure, and Mechanical Properties of Directionally Solidified Sn-0.7 wt.%Cu Solder Alloys Containing 0 ppm to 1000 ppm Ni. <i>Journal of Electronic Materials</i> , <b>2013</b> , 42, 179-191	1.9	37
281	Thermal parameters and microstructure during transient directional solidification of a monotectic Al <sub>80</sub> Bi <sub>20</sub> alloy. <i>Journal of Alloys and Compounds</i> , <b>2009</b> , 475, 347-351	5.7	37
280	Microstructure features affecting mechanical properties and corrosion behavior of a hypoeutectic Al <sub>80</sub> Ni <sub>20</sub> alloy. <i>Materials &amp; Design</i> , <b>2010</b> , 31, 4485-4489		37
279	Melt characteristics and solidification growth direction with respect to gravity affecting the interfacial heat transfer coefficient of chill castings. <i>Materials &amp; Design</i> , <b>2009</b> , 30, 3592-3601		36
278	Characterization of Dendritic Microstructure, Intermetallic Phases, and Hardness of Directionally Solidified Al-Mg and Al-Mg-Si Alloys. <i>Metallurgical and Materials Transactions A: Physical Metallurgy and Materials Science</i> , <b>2015</b> , 46, 3342-3355	2.3	35
277	Microstructural development and mechanical properties of a near-eutectic directionally solidified Sn <sub>60.7</sub> Bi <sub>39.3</sub> solder alloy. <i>Materials Characterization</i> , <b>2015</b> , 107, 43-53	3.9	35
276	On array models theoretical predictions versus measurements for the growth of cells and dendrites in the transient solidification of binary alloys. <i>Philosophical Magazine</i> , <b>2011</b> , 91, 1705-1723	1.6	35
275	Combined effects of Ag content and cooling rate on microstructure and mechanical behavior of Sn <sub>60.7</sub> Ag <sub>39.3</sub> Cu <sub>0.7</sub> solders. <i>Materials &amp; Design</i> , <b>2013</b> , 45, 377-383		33
274	Globular-to-needle Zn-rich phase transition during transient solidification of a eutectic Sn <sub>60.7</sub> Zn <sub>39.3</sub> solder alloy. <i>Materials Letters</i> , <b>2009</b> , 63, 1314-1316	3.3	33
273	Investigation of intermetallics in hypoeutectic Al <sub>80</sub> Fe <sub>20</sub> alloys by dissolution of the Al matrix. <i>Intermetallics</i> , <b>2009</b> , 17, 753-761	3.5	33
272	Microstructure and solidification thermal parameters in thin strip continuous casting of a stainless steel. <i>Journal of Materials Processing Technology</i> , <b>2004</b> , 150, 255-262	5.3	32
271	Evaluation of solder/substrate thermal conductance and wetting angle of Sn <sub>60.7</sub> Cu <sub>39.3</sub> ( <sub>0.1</sub> Ni) solder alloys. <i>Materials Letters</i> , <b>2015</b> , 142, 163-167	3.3	31
270	The effects of Zn segregation and microstructure length scale on the corrosion behavior of a directionally solidified Mg-25 wt.%Zn alloy. <i>Journal of Alloys and Compounds</i> , <b>2017</b> , 723, 649-660	5.7	31
269	Microstructural modification by laser surface remelting and its effect on the corrosion resistance of an Al <sub>80</sub> Zn <sub>20</sub> Si casting alloy. <i>Applied Surface Science</i> , <b>2008</b> , 254, 2763-2770	6.7	31



268	Thermosolutal convective effects on dendritic array spacings in downward transient directional solidification of AlâBi alloys. <i>Journal of Alloys and Compounds</i> , <b>2005</b> , 403, 228-238	5.7	31
267	On macrosegregation in ternary AlâCuâBi alloys: numerical and experimental analysis. <i>Scripta Materialia</i> , <b>2004</b> , 50, 407-411	5.6	31
266	Growth direction and Si alloying affecting directionally solidified structures of AlâCuâBi alloys. <i>Materials Science and Technology</i> , <b>2015</b> , 31, 1103-1112	1.5	30
265	Microstructure, phases morphologies and hardness of a BiâAg eutectic alloy for high temperature soldering applications. <i>Materials &amp; Design</i> , <b>2014</b> , 58, 482-490		30
264	Snâ0.7 wt%Cuâ(xNi) alloys: Microstructureâmechanical properties correlations with solder/substrate interfacial heat transfer coefficient. <i>Journal of Alloys and Compounds</i> , <b>2015</b> , 632, 274-285	5.7	30
263	Cellular growth during transient directional solidification of PbâBb alloys. <i>Journal of Alloys and Compounds</i> , <b>2006</b> , 422, 227-238	5.7	30
262	The effect of microstructure length scale on dry sliding wear behaviour of monotectic Al-Bi-Sn alloys. <i>Journal of Alloys and Compounds</i> , <b>2016</b> , 689, 767-776	5.7	30
261	Inter-relation of Microstructural Features and Dry Sliding Wear Behavior of Monotectic AlâBi and AlâBb Alloys. <i>Tribology Letters</i> , <b>2014</b> , 55, 111-120	2.8	29
260	Mechanical and corrosion resistances of a Snâ0.7 wt.%Cu lead-free solder alloy. <i>Microelectronics Reliability</i> , <b>2014</b> , 54, 1392-1400	1.2	29
259	Complex eutectic growth and Bi precipitation in ternary Sn-Bi-Cu and Sn-Bi-Ag alloys. <i>Journal of Alloys and Compounds</i> , <b>2017</b> , 691, 600-605	5.7	29
258	The interrelation between mechanical properties, corrosion resistance and microstructure of PbâSn casting alloys for lead-acid battery components. <i>Journal of Power Sources</i> , <b>2010</b> , 195, 621-630	8.9	29
257	Tertiary dendrite arm spacing during downward transient solidification of AlâCu and AlâBi alloys. <i>Materials Letters</i> , <b>2006</b> , 60, 1871-1874	3.3	29
256	Electrochemical behavior of Zn-rich ZnâCu peritectic alloys affected by macrosegregation and microstructural array. <i>Electrochimica Acta</i> , <b>2012</b> , 76, 218-228	6.7	28
255	Microstructural development and mechanical properties of hypereutectic SnâCu solderalloys. <i>Materials Science &amp; Engineering A: Structural Materials: Properties, Microstructure and Processing</i> , <b>2013</b> , 568, 195-201	5.3	28
254	The effects of microstructure and intermetallic phases of directionally solidified AlâBe alloys on microhardness. <i>Materials Letters</i> , <b>2012</b> , 89, 291-295	3.3	28
253	Application of a Solidification Mathematical Model and a Genetic Algorithm in the Optimization of Strand Thermal Profile Along the Continuous Casting of Steel. <i>Materials and Manufacturing Processes</i> , <b>2005</b> , 20, 421-434	4.1	28
252	Application of a heuristic search technique for the improvement of spray zones cooling conditions in continuously cast steel billets. <i>Applied Mathematical Modelling</i> , <b>2006</b> , 30, 104-115	4.5	28
251	Metalâhold heat transfer coefficients during horizontal and vertical Unsteady-State solidification of AlâCu and SnâBb Alloys. <i>Inverse Problems in Science and Engineering</i> , <b>2004</b> , 12, 279-296	1.3	28

250	Interconnection of thermal parameters, microstructure and mechanical properties in directionally solidified Sn <sub>85</sub> Pb <sub>15</sub> lead-free solder alloys. <i>Materials Characterization</i> , <b>2015</b> , 106, 52-61	3.9	27
249	Microstructure–wear behavior correlation on a directionally solidified Al–In monotectic alloy. <i>Tribology International</i> , <b>2013</b> , 66, 182-186	4.9	27
248	Laser remelting of Al–1.5 wt%Fe alloy surfaces: Numerical and experimental analyses. <i>Optics and Lasers in Engineering</i> , <b>2011</b> , 49, 490-497	4.6	27
247	Experimental analysis of the columnar-to-equiaxed transition in directionally solidified Al–Ni and Al–Sn alloys. <i>Materials Letters</i> , <b>2007</b> , 61, 2135-2138	3.3	27
246	Evaluation of heat transfer coefficients along the secondary cooling zones in the continuous casting of steel billets. <i>Inverse Problems in Science and Engineering</i> , <b>2006</b> , 14, 687-700	1.3	27
245	Monotectic Al–Bi–Sn alloys directionally solidified: Effects of Bi content, growth rate and cooling rate on the microstructural evolution and hardness. <i>Journal of Alloys and Compounds</i> , <b>2015</b> , 653, 243-254	5.7	26
244	Dendritic Microstructure Affecting Mechanical Properties and Corrosion Resistance of an Al-9 wt% Si Alloy. <i>Materials and Manufacturing Processes</i> , <b>2007</b> , 22, 328-332	4.1	26
243	Cooling thermal parameters and microstructure features of directionally solidified ternary Sn–Bi–(Cu,Ag) solder alloys. <i>Materials Characterization</i> , <b>2016</b> , 114, 30-42	3.9	25
242	The effects of Ag content and dendrite spacing on the electrochemical behavior of Pb–Ag alloys for Pb-acid battery components. <i>Journal of Power Sources</i> , <b>2013</b> , 238, 324-335	8.9	25
241	Assessment of a new model for heat flow during unidirectional solidification of metals. <i>International Journal of Heat and Mass Transfer</i> , <b>1980</b> , 23, 773-782	4.9	25
240	Cu and Ag additions affecting the solidification microstructure and tensile properties of Sn–Bi lead-free solder alloys. <i>Materials Science &amp; Engineering A: Structural Materials: Properties, Microstructure and Processing</i> , <b>2017</b> , 705, 325-334	5.3	24
239	The application of a new solidification heat flow model to splat cooling. <i>Journal of Materials Science</i> , <b>1981</b> , 16, 1643-1653	4.3	24
238	Plate-like cell growth during directional solidification of a Zn–0wt%Sn high-temperature lead-free solder alloy. <i>Materials Science and Engineering B: Solid-State Materials for Advanced Technology</i> , <b>2014</b> , 182, 29-36	3.1	23
237	Interrelation of cell spacing, intermetallic compounds and hardness on a directionally solidified Al–0.0Fe–0.0Ni alloy. <i>Materials &amp; Design</i> , <b>2013</b> , 51, 342-346		23
236	Electrochemical corrosion of Pb–1wt% Sn and Pb–2.5wt% Sn alloys for lead-acid battery applications. <i>Journal of Power Sources</i> , <b>2009</b> , 194, 1120-1127	8.9	23
235	A solidification heat transfer model and a neural network based algorithm applied to the continuous casting of steel billets and blooms. <i>Modelling and Simulation in Materials Science and Engineering</i> , <b>2005</b> , 13, 1071-1087	2	23
234	Effects of the longitudinal and transversal structural grain morphologies upon the corrosion resistance of zinc and aluminium specimens. <i>Revista De Metalurgia</i> , <b>2005</b> , 41, 176-180	0.4	23
233	Interconnection of Zn content, macrosegregation, dendritic growth, nature of intermetallics and hardness in directionally solidified Mg–Zn alloys. <i>Journal of Alloys and Compounds</i> , <b>2016</b> , 662, 1-10	5.7	22



232	Assessment of Tertiary Dendritic Growth and Its Effects on Mechanical Properties of Directionally Solidified Sn-0.7Cu-xAg Solder Alloys. <i>Journal of Electronic Materials</i> , <b>2014</b> , 43, 1347-1361	1.9	22
231	Microstructural development of hypoeutectic Znâ€“(10â€“40)wt%Sn solder alloys and impacts of interphase spacing and macrosegregation pattern on hardness. <i>Journal of Alloys and Compounds</i> , <b>2015</b> , 647, 989-996	5.7	22
230	Effects of cell morphology and macrosegregation of directionally solidified Zn-rich Znâ€“Cu alloys on the resulting microhardness. <i>Materials Letters</i> , <b>2012</b> , 80, 106-109	3.3	22
229	EIS parameters and cell spacings of an Alâ€“Bi alloy in NaCl solution. <i>Electrochimica Acta</i> , <b>2013</b> , 108, 781-787	1.7	22
228	Corrosion behavior of hypoeutectic Al-Cu alloys in H2SO4 and NaCl solutions. <i>Acta Metallurgica Sinica (English Letters)</i> , <b>2009</b> , 22, 241-246	2.5	22
227	Microstructural development in Alâ€“Sn alloys directionally solidified under transient heat flow conditions. <i>Materials Chemistry and Physics</i> , <b>2008</b> , 109, 87-98	4.4	22
226	Experimental impurity segregation and numerical analysis based on variable solute distribution coefficients during multi-pass zone refining of aluminum. <i>Journal of Crystal Growth</i> , <b>2008</b> , 310, 1274-1280	1.6	22
225	Influence of refining time on nonmetallic inclusions in a low-carbon, silicon-killed steel. <i>Materials Characterization</i> , <b>2003</b> , 51, 301-308	3.9	22
224	Effects of Solidification Thermal Parameters on Microstructure and Mechanical Properties of Sn-Bi Solder Alloys. <i>Journal of Electronic Materials</i> , <b>2017</b> , 46, 1754-1769	1.9	21
223	Microstructure and Tensile/Corrosion Properties Relationships of Directionally Solidified Alâ€“Cuâ€“Bi Alloys. <i>Metals and Materials International</i> , <b>2018</b> , 24, 1058-1076	2.4	21
222	The effect of the growth rate on microsegregation: Experimental investigation in hypoeutectic Alâ€“Fe and Alâ€“Cu alloys directionally solidified. <i>Journal of Alloys and Compounds</i> , <b>2013</b> , 561, 193-200	5.7	21
221	Evaluation of heat transfer coefficients during upward and downward transient directional solidification of Alâ€“Bi alloys. <i>Structural and Multidisciplinary Optimization</i> , <b>2006</b> , 31, 241-248	3.6	21
220	Investigation of nonmetallic inclusions in continuously cast carbon steel by dissolution of the ferritic matrix. <i>Materials Characterization</i> , <b>2002</b> , 48, 255-261	3.9	21
219	Cell/dendrite transition and electrochemical corrosion of Pbâ€“Sb alloys for lead-acid battery applications. <i>Journal of Power Sources</i> , <b>2011</b> , 196, 6567-6572	8.9	20
218	Comparison of electrochemical performance of as-cast Pbâ€“1wt.% Sn and Pbâ€“1wt.% Sb alloys for lead-acid battery components. <i>Journal of Power Sources</i> , <b>2010</b> , 195, 1726-1730	8.9	20
217	The roles of Al2Cu and of dendritic refinement on surface corrosion resistance of hypoeutectic Alâ€“Cu alloys immersed in H2SO4. <i>Journal of Alloys and Compounds</i> , <b>2007</b> , 443, 87-93	5.7	20
216	Modeling of macrosegregation and microporosity formation during transient directional solidification of aluminum alloys. <i>Materials Science &amp; Engineering A: Structural Materials: Properties, Microstructure and Processing</i> , <b>2006</b> , 435-436, 150-157	5.3	20
215	Theoretical and experimental analysis of inverse segregation during unidirectional solidification of an Alâ€“2 wt.% Cu alloy. <i>Scripta Materialia</i> , <b>2003</b> , 49, 339-344	5.6	20

214	AlâBe hypoeutectic alloys directionally solidified under steady-state and unsteady-state conditions. <i>Journal of Alloys and Compounds</i> , <b>2010</b> , 504, 205-210	5.7	19
213	Electrochemical Corrosion Behavior of as-cast Zn-rich Zn-Mg Alloys in a 0.06M NaCl Solution. <i>International Journal of Electrochemical Science</i> , <b>2017</b> , 5264-5283	2.2	18
212	Influences of solute content, melt superheat and growth direction on the transient metal/mold interfacial heat transfer coefficient during solidification of SnâPb alloys. <i>Materials Chemistry and Physics</i> , <b>2008</b> , 111, 444-454	4.4	18
211	The correlation of microstructure features, dry sliding wear behavior, hardness and tensile properties of Al-2wt%Mg-Zn alloys. <i>Journal of Alloys and Compounds</i> , <b>2018</b> , 764, 267-278	5.7	17
210	Microstructure morphologies during the transient solidification of hypomonotectic and monotectic AlâPb alloys. <i>Journal of Alloys and Compounds</i> , <b>2011</b> , 509, 10098-10104	5.7	17
209	The application of computational thermodynamics and a numerical model for the determination of surface tension and GibbsâThomson coefficient of aluminum based alloys. <i>Thermochimica Acta</i> , <b>2011</b> , 523, 142-149	2.9	17
208	Correlation between dendrite arm spacing and microhardness during unsteady-state directional solidification of AlâNi alloys. <i>Philosophical Magazine Letters</i> , <b>2011</b> , 91, 337-343	1	17
207	Near-eutectic Zn-Mg alloys: Interrelations of solidification thermal parameters, microstructure length scale and tensile/corrosion properties. <i>Current Applied Physics</i> , <b>2019</b> , 19, 582-598	2.6	16
206	Cooling thermal parameters, microstructural spacing and mechanical properties in a directionally solidified hypereutectic AlâBi alloy. <i>Philosophical Magazine Letters</i> , <b>2016</b> , 96, 228-237	1	16
205	A comparative analysis of microstructural features, tensile properties and wettability of hypoperitectic and peritectic Sn-Sb solder alloys. <i>Microelectronics Reliability</i> , <b>2018</b> , 81, 150-158	1.2	15
204	Electrochemical corrosion behavior of gas atomized AlâNi alloy powders. <i>Electrochimica Acta</i> , <b>2012</b> , 69, 371-378	6.7	15
203	Directional solidification of a Sn-0.2Ni solder alloy in water-cooled copper and steel molds: Related effects on the matrix micromorphology, nature of intermetallics and tensile properties. <i>Journal of Alloys and Compounds</i> , <b>2017</b> , 723, 1039-1052	5.7	15
202	An alternative thermal approach to evaluate the wettability of solder alloys. <i>Applied Thermal Engineering</i> , <b>2016</b> , 107, 431-440	5.8	15
201	Horizontally Solidified Alâ3 wt%Cuâ(0.5 wt%Mg) Alloys: Tailoring Thermal Parameters, Microstructure, Microhardness, and Corrosion Behavior. <i>Acta Metallurgica Sinica (English Letters)</i> , <b>2019</b> , 32, 695-709	2.5	15
200	Dendritic Growth, Solidification Thermal Parameters, and Mg Content Affecting the Tensile Properties of Al-Mg-1.5 Wt Pct Fe Alloys. <i>Metallurgical and Materials Transactions A: Physical Metallurgy and Materials Science</i> , <b>2017</b> , 48, 1841-1855	2.3	14
199	The use of a directional solidification technique to investigate the interrelationship of thermal parameters, microstructure and microhardness of BiâAg solder alloys. <i>Materials Characterization</i> , <b>2014</b> , 96, 115-125	3.9	14
198	The effects of dendritic arm spacing (as-cast) and aging time (solution heat-treated) of AlâCu alloy on hardness. <i>Journal of Alloys and Compounds</i> , <b>2013</b> , 549, 324-335	5.7	14
197	Directionally solidified dilute Zn-Mg alloys: Correlation between microstructure and corrosion properties. <i>Journal of Alloys and Compounds</i> , <b>2017</b> , 723, 536-547	5.7	14

196	Development of solidification microstructure and tensile mechanical properties of Sn-0.7Cu and Sn-0.7Cu-2.0Ag solders. <i>Journal of Materials Science: Materials in Electronics</i> , <b>2014</b> , 25, 478-486	2.1	14
195	Hot corrosion resistance of a Pb-Sb alloy for lead acid battery grids. <i>Journal of Power Sources</i> , <b>2008</b> , 185, 1471-1477	8.9	14
194	The correlation between thermal variables and secondary dendrite arm spacing during solidification of horizontal cylinders of Sn-Pb alloys. <i>Journal of Alloys and Compounds</i> , <b>2005</b> , 399, 110-117	5.7	14
193	On an expression for the growth of secondary dendrite arm spacing during non-equilibrium solidification of multicomponent alloys: Validation against ternary aluminum-based alloys. <i>Journal of Manufacturing Processes</i> , <b>2018</b> , 35, 634-650	5	14
192	An Effective Inverse Heat Transfer Procedure Based on Evolutionary Algorithms to Determine Cooling Conditions of a Steel Continuous Casting Machine. <i>Materials and Manufacturing Processes</i> , <b>2015</b> , 30, 414-424	4.1	13
191	Thermal Parameters and Microstructural Development in Directionally Solidified Zn-Rich Zn-Mg Alloys. <i>Metallurgical and Materials Transactions A: Physical Metallurgy and Materials Science</i> , <b>2016</b> , 47, 3052-3064	2.3	13
190	The effects of tertiary dendrite arm spacing and segregation on the corrosion behavior of a Pb-Sb alloy for lead-acid battery components. <i>Journal of Power Sources</i> , <b>2012</b> , 207, 183-190	8.9	13
189	Corrosion Performance Based on the Microstructural Array of Al-Based Monotectic Alloys in a NaCl Solution. <i>Journal of Materials Engineering and Performance</i> , <b>2014</b> , 23, 333-341	1.6	13
188	Inverse segregation during transient directional solidification of an Al-Sn alloy: Numerical and experimental analysis. <i>Materials Chemistry and Physics</i> , <b>2009</b> , 115, 116-121	4.4	13
187	The influences of macrosegregation, intermetallic particles, and dendritic spacing on the electrochemical behavior of hypoeutectic Al-Cu alloys. <i>Microscopy Research and Technique</i> , <b>2007</b> , 70, 928-37	2.8	13
186	Numerical and experimental analysis of an approach based on variable solute distribution coefficients during purification by zone refining. <i>Separation and Purification Technology</i> , <b>2007</b> , 52, 504-511	8.3	13
185	Thermal analysis during solidification of an Al-Cu eutectic alloy: interrelation of thermal parameters, microstructure and hardness. <i>Journal of Thermal Analysis and Calorimetry</i> , <b>2019</b> , 137, 983-996	4.1	12
184	The Growth of Secondary Dendritic Arms in Directionally Solidified Al-Si-Cu Alloys: A Comparative Study with Binary Al-Si Alloys. <i>Applied Mechanics and Materials</i> , <b>2015</b> , 719-720, 102-105	0.3	12
183	Solder/substrate interfacial thermal conductance and wetting angles of Bi-Ag solder alloys. <i>Journal of Materials Science: Materials in Electronics</i> , <b>2016</b> , 27, 1994-2003	2.1	12
182	Electrochemical and Mechanical Behavior of Lead-Silver and Lead-Bismuth Casting Alloys for Lead-Acid Battery Components. <i>Metallurgical and Materials Transactions A: Physical Metallurgy and Materials Science</i> , <b>2015</b> , 46, 4255-4267	2.3	12
181	Electrochemical behaviour of a Pb-Sb alloy in 0.5M NaCl and 0.5M H <sub>2</sub> SO <sub>4</sub> solutions. <i>Materials &amp; Design</i> , <b>2012</b> , 34, 660-665		12
180	Two-dimensional numerical model for the analysis of macrosegregation during solidification. <i>Computational Materials Science</i> , <b>2009</b> , 46, 358-366	3.2	12
179	Factors affecting solidification thermal variables along the cross-section of horizontal cylindrical ingots. <i>Materials Science &amp; Engineering A: Structural Materials: Properties, Microstructure and Processing</i> , <b>2005</b> , 397, 239-248	5.3	12

178	Numerical analysis of solidification of complex shaped bodies: coupling of mesh elements of different geometries. <i>Materials Science &amp; Engineering A: Structural Materials: Properties, Microstructure and Processing</i> , <b>2000</b> , 277, 198-205	5.3	12
177	Experimental study of the evolution of tertiary dendritic arms and microsegregation in directionally solidified Al <sub>85</sub> Si <sub>15</sub> alloys castings. <i>Journal of Materials Research and Technology</i> , <b>2019</b> , 8, 1515-1521	5.5	12
176	Tailoring microstructure, tensile properties and fracture process via transient directional solidification of Zn-Sn alloys. <i>Materials Science &amp; Engineering A: Structural Materials: Properties, Microstructure and Processing</i> , <b>2018</b> , 712, 127-132	5.3	12
175	Transient directional solidification of a eutectic Al <sub>85</sub> Si <sub>15</sub> alloy: Macrostructure, microstructure, dendritic growth and hardness. <i>Materialia</i> , <b>2019</b> , 7, 100358	3.2	11
174	Application of computational thermodynamics to the determination of thermophysical properties as a function of temperature for multicomponent Al-based alloys. <i>Thermochimica Acta</i> , <b>2015</b> , 619, 1-7	2.9	11
173	The effects of Cr addition on microstructure, hardness and tensile properties of as-cast Al <sub>85</sub> Si <sub>15</sub> Cr alloys. <i>Journal of Materials Research and Technology</i> , <b>2020</b> , 9, 6620-6631	5.5	11
172	Cellular growth of single-phase Zn <sub>85</sub> Ag alloys unidirectionally solidified. <i>Materials Chemistry and Physics</i> , <b>2014</b> , 143, 895-899	4.4	11
171	Modeling and experimental analysis of macrosegregation during transient solidification of a ternary Al <sub>85</sub> Si <sub>15</sub> Cr alloy. <i>Philosophical Magazine Letters</i> , <b>2009</b> , 89, 769-777	1	11
170	Gravity-driven inverse segregation during transient upward directional solidification of Sn <sub>85</sub> Pb <sub>15</sub> hypoeutectic alloys. <i>Journal of Alloys and Compounds</i> , <b>2009</b> , 475, 396-400	5.7	11
169	Electrochemical corrosion behaviour of a Ti-IF steel and a SAE 1020 steel in a 0.5 M NaCl solution. <i>Materials and Corrosion - Werkstoffe Und Korrosion</i> , <b>2010</b> , 61, 407-411	1.6	11
168	Mathematical modeling and experimental analysis of the hardened zone in laser treatment of a 1045 AISI steel. <i>Materials Research</i> , <b>2004</b> , 7, 349-354	1.5	11
167	Investigation of the chemical composition of nonmetallic inclusions utilizing ternary phase diagrams. <i>Materials Characterization</i> , <b>2002</b> , 49, 437-443	3.9	11
166	Processing, As-Cast Microstructure and Wear Characteristics of a Monotectic Al-Bi-Cu Alloy. <i>Journal of Materials Engineering and Performance</i> , <b>2019</b> , 28, 1201-1212	1.6	11
165	Correlation between microstructure and corrosion behaviour of Bi-Zn solder alloys. <i>Corrosion Engineering Science and Technology</i> , <b>2019</b> , 54, 362-368	1.7	10
164	The use of computational thermodynamics for the determination of surface tension and Gibbs-Thomson coefficient of multicomponent alloys. <i>Continuum Mechanics and Thermodynamics</i> , <b>2018</b> , 30, 1145-1154	3.5	10
163	Microstructure characterization of a directionally solidified Mg-12wt.%Zn alloy: Equiaxed dendrites, eutectic mixture and type/ morphology of intermetallics. <i>Materials Chemistry and Physics</i> , <b>2018</b> , 204, 105-131	4.4	10
162	Numerical and experimental modelling of two-dimensional unsteady heat transfer during inward solidification of square billets. <i>Applied Thermal Engineering</i> , <b>2016</b> , 96, 454-462	5.8	10
161	Inward solidification of cylinders: Reversal in the growth rate and microstructure evolution. <i>Applied Thermal Engineering</i> , <b>2013</b> , 61, 577-582	5.8	10

160	Interrelationship of thermal parameters, microstructure and microhardness of directionally solidified BiâZn solder alloys. <i>Microelectronics Reliability</i> , <b>2017</b> , 78, 100-110	1.2	10
159	Application of a Genetic Algorithm to Optimize Purification in the Zone Refining Process. <i>Materials and Manufacturing Processes</i> , <b>2011</b> , 26, 493-500	4.1	10
158	Electrolyte features and microstructure affecting the electrochemical performance of a PbâB alloy for lead-acid battery components. <i>Electrochimica Acta</i> , <b>2011</b> , 56, 8457-8462	6.7	10
157	Microstructural Development in a Ternary Al-Cu-Si Alloy during Transient Solidification. <i>Materials Science Forum</i> , <b>2010</b> , 636-637, 643-650	0.4	10
156	The Role of Macrostructural and Microstructural Morphologies on the Corrosion Resistance of Zn and a Zn-4% Al Alloy. <i>Materials and Manufacturing Processes</i> , <b>2007</b> , 22, 341-345	4.1	10
155	Interrelation of wettabilityâmicrostructureâtensile strength of lead-free SnâAg and SnâBi solder alloys. <i>Science and Technology of Welding and Joining</i> , <b>2016</b> , 21, 429-437	3.7	10
154	Steady and unsteady state peritectic solidification. <i>Materials Science and Technology</i> , <b>2015</b> , 31, 105-114	1.5	9
153	Phase-Field Simulation of Microsegregation and Dendritic Growth During Solidification of Hypoeutectic Al-Cu alloys. <i>Materials Research</i> , <b>2017</b> , 20, 423-429	1.5	9
152	Inward and outward solidification of cylindrical castings: The role of the metal/mold heat transfer coefficient. <i>Materials Chemistry and Physics</i> , <b>2012</b> , 136, 545-554	4.4	9
151	Effects of Melt Superheating on the Microstructure and Tensile Properties of a Ternary Al-15 Wt Pct Si-1.5 Wt Pct Mg Alloy. <i>Metallurgical and Materials Transactions A: Physical Metallurgy and Materials Science</i> , <b>2019</b> , 50, 1308-1322	2.3	9
150	Microstructure Growth Morphologies, Macrosegregation, and Microhardness in BiâB Thermal Interface Alloys. <i>Advanced Engineering Materials</i> , <b>2020</b> , 22, 1901592	3.5	8
149	Performance of New Pb-Bi Alloys for Pb-Acid Battery Applications: EIS and Polarization Study. <i>Journal of Materials Engineering and Performance</i> , <b>2016</b> , 25, 2211-2221	1.6	8
148	An Alternative to the Recycling of Fe-Contaminated Al. <i>Journal of Sustainable Metallurgy</i> , <b>2018</b> , 4, 412-426	2.7	8
147	Cellular growth during the transient directional solidification of Zn-rich ZnâCu monophasic and peritectic alloys. <i>Journal of Physics and Chemistry of Solids</i> , <b>2012</b> , 73, 1173-1181	3.9	8
146	Interconnection of thermal parameters, microstructure, macrosegregation and microhardness of unidirectionally solidified Zn-rich ZnâAg peritectic alloys. <i>Materials &amp; Design</i> , <b>2014</b> , 63, 848-855		8
145	Experimental analysis of corrosion resistance on columnar to equiaxed transition region of as cast structures of AlâCu alloys. <i>Materials Science and Technology</i> , <b>2008</b> , 24, 1433-1437	1.5	8
144	Analytical technique for the determination of solidification rates during the inward freezing of cylinders. <i>Journal of Materials Science</i> , <b>1983</b> , 18, 3578-3590	4.3	8
143	The influence of melt convection on dendritic spacing of downward unsteady-state directionally solidified Sn-Pb alloys. <i>Materials Research</i> , <b>2006</b> , 9, 51-57	1.5	8



142	The role of eutectic colonies in the tensile properties of a Sn-Zn eutectic solder alloy. <i>Materials Science &amp; Engineering A: Structural Materials: Properties, Microstructure and Processing</i> , <b>2020</b> , 776, 138959	5.3	8
141	The application of an analytical model to solve an inverse heat conduction problem: Transient solidification of a Sn-Sb peritectic solder alloy on distinct substrates. <i>Journal of Manufacturing Processes</i> , <b>2019</b> , 48, 164-173	5	8
140	Cellular-to-Dendritic and Dendritic-to-Cellular Morphological Transitions in a Ternary Al-Mg-Si Alloy. <i>IOP Conference Series: Materials Science and Engineering</i> , <b>2019</b> , 529, 012018	0.4	7
139	Effects of solidification thermal parameters and Bi doping on silicon size, morphology and mechanical properties of Al-15wt.% Si-3.2wt.% Bi and Al-18wt.% Si-3.2wt.% Bi alloys. <i>Journal of Materials Research and Technology</i> , <b>2020</b> , 9, 3460-3470	5.5	7
138	Determination of heat capacity of pure metals, compounds and alloys by analytical and numerical methods. <i>Thermochimica Acta</i> , <b>2019</b> , 682, 178418	2.9	7
137	Rapid solidification of an Al-5Ni alloy processed by spray forming. <i>Materials Research</i> , <b>2012</b> , 15, 779-785	1.5	7
136	Evolution of eutectic spacing during unidirectional solidification of Al-Ni alloys. <i>Materials Research</i> , <b>2011</b> , 14, 268-273	1.5	7
135	The variation of the metal/mold heat transfer coefficient along the cross section of cylindrical shaped castings. <i>Inverse Problems in Science and Engineering</i> , <b>2006</b> , 14, 467-481	1.3	7
134	Analysis of current dendritic growth models during downward transient directional solidification of Sn-Bi alloys. <i>Materials Letters</i> , <b>2005</b> , 59, 1691-1695	3.3	7
133	Different immersion periods and aqueous solutions effects upon the corrosion resistance of zinc and aluminium specimens. <i>Revista De Metalurgia</i> , <b>2005</b> , 41, 160-164	0.4	7
132	The application of numerical and analytical approaches for the determination of thermophysical properties of Al-Bi-Cu-Mg alloys. <i>Continuum Mechanics and Thermodynamics</i> , <b>2020</b> , 32, 1231-1244	3.5	7
131	On the prediction of temperature-dependent viscosity of multicomponent liquid alloys. <i>Continuum Mechanics and Thermodynamics</i> , <b>2019</b> , 31, 1369-1385	3.5	7
130	Cellular/dendritic transition, dendritic growth and microhardness in directionally solidified monophasic Sn-2%Sb alloy. <i>Transactions of Nonferrous Metals Society of China</i> , <b>2018</b> , 28, 1679-1686	3.3	7
129	Tailoring of Microstructures and Tensile Properties in the Solidification of Al-11Si(-xCu) Brazing Alloys. <i>Metals</i> , <b>2018</b> , 8, 784	2.3	7
128	An artificial immune system algorithm applied to the solution of an inverse problem in unsteady inward solidification. <i>Advances in Engineering Software</i> , <b>2018</b> , 121, 178-187	3.6	7
127	Assessing microstructure and mechanical behavior changes in a Sn-Sb solder alloy induced by cooling rate. <i>Journal of Alloys and Compounds</i> , <b>2019</b> , 809, 151780	5.7	6
126	The Roles of Mn and Ni Additions to Fe-Contaminated Al in Neutralizing Fe and Stabilizing the Cellular $\alpha$ -Al Microstructure. <i>Journal of Sustainable Metallurgy</i> , <b>2019</b> , 5, 561-580	2.7	6
125	A comparison of experimental time-secondary dendritic spacing and coarsening models for Al-Si-Cu alloys. <i>Journal of Manufacturing Processes</i> , <b>2020</b> , 54, 14-18	5	6



124	Effects of cobalt and solidification cooling rate on intermetallic phases and tensile properties of a -Cu, -Zn, -Fe containing Al-Si alloy. <i>International Journal of Advanced Manufacturing Technology</i> , <b>2020</b> , 107, 717-730	3.2	6
123	Evaluation of thermophysical properties of Al-Sn-Bi alloys based on computational thermodynamics and validation by numerical and experimental simulation of solidification. <i>Journal of Chemical Thermodynamics</i> , <b>2016</b> , 98, 9-20	2.9	6
122	Length scale of the dendritic microstructure affecting tensile properties of Al-(Ag)-Cu alloys. <i>International Journal of Modern Physics B</i> , <b>2016</b> , 30, 1550261	1.1	6
121	The roles of dendritic spacings and Ag <sub>3</sub> Sn intermetallics on hardness of the SAC307 solder alloy. <i>Microelectronics Reliability</i> , <b>2014</b> , 54, 2929-2934	1.2	6
120	On the growth of the minority phase during downward transient directional solidification of hypomonotectic and monotectic Al-Pb alloys. <i>Journal of Materials Science</i> , <b>2012</b> , 47, 5581-5589	4.3	6
119	The Interrelation between Casting Size, Steel Grade, and Temperature Evolution Along the Mold Length and at the Strand Surface during Continuous Casting of Steel. <i>Materials and Manufacturing Processes</i> , <b>2011</b> , 26, 113-126	4.1	6
118	Primary dendrite arm spacing during transient directional solidification of Al alloys with low redistribution coefficients. <i>Philosophical Magazine Letters</i> , <b>2009</b> , 89, 779-786	1	6
117	Effects of Microstructural Arrangement on Hot Corrosion Resistance of a Pb-Sb Alloy for Battery Grids. <i>Materials Science Forum</i> , <b>2008</b> , 595-598, 851-859	0.4	6
116	Theoretical - Experimental Analysis of Cellular and Primary Dendritic Spacings during Unidirectional Solidification of Sn-Pb Alloys. <i>Materials Research</i> , <b>2002</b> , 5, 391-397	1.5	6
115	Thermal behaviour during the inward solidification of cylinders and spheres and the correlation with structural effects. <i>International Journal of Cast Metals Research</i> , <b>1998</b> , 11, 187-195	1	6
114	Influence of melt convection on dendritic spacings of downward unsteady-state directionally solidified Al-Cu alloys <b>2004</b> , 383, 271-271		6
113	Comparing the roles of Sb and Bi on microstructures and application properties of the Al-15% Si alloy. <i>Journal of Alloys and Compounds</i> , <b>2021</b> , 878, 160343	5.7	6
112	Measurement and interrelation of length scale of dendritic microstructures, tensile properties, and machinability of Al-9 wt% Si-(1 wt% Bi) alloys. <i>International Journal of Advanced Manufacturing Technology</i> , <b>2019</b> , 105, 1391-1410	3.2	5
111	Effects of Macrosegregation and Microstructure on the Corrosion Resistance and Hardness of a Directionally Solidified Zn-5.0wt.%Mg Alloy. <i>Materials Research</i> , <b>2019</b> , 22,	1.5	5
110	Length scale of solidification microstructure tailoring corrosion resistance and microhardness in T6 heat treatment of an Al-Cu-Mg alloy. <i>Corrosion Engineering Science and Technology</i> , <b>2020</b> , 55, 471-479	1.7	5
109	Microstructural Morphologies and Experimental Growth Laws during Solidification of Monotectic and Hypermonotectic Al-Pb Alloys. <i>Journal of Materials Science and Technology</i> , <b>2014</b> , 30, 401-407	9.1	5
108	Primary Dendrite ARM Spacing Effects upon Mechanical Properties of an Al-BWt%Cu-Wt%Li Alloy. <i>Advanced Structured Materials</i> , <b>2017</b> , 215-229	0.6	5
107	The columnar to equiaxed transition in the directional solidification of aluminum based multicomponent alloys. <i>Revista Escola De Minas</i> , <b>2015</b> , 68, 85-90		5

106	Influência na microestrutura e na microdureza decorrente da adição de 4%Ag na liga Al-4%Cu solidificada unidirecionalmente. <i>Revista Materia</i> , <b>2015</b> , 20, 992-1007	0.8	5
105	Microstructural development during transient directional solidification of a hypomonotectic Al <sub>40</sub> Th alloy. <i>Philosophical Magazine Letters</i> , <b>2012</b> , 92, 442-450	1	5
104	Application of an Artificial Intelligence Technique to Improve Purification in the Zone Refining Process. <i>Journal of Electronic Materials</i> , <b>2010</b> , 39, 49-55	1.9	5
103	Characterization of microstructure and wear resistance of a monotectic Al-Bi-Zn alloy. <i>Journal of Physics and Chemistry of Solids</i> , <b>2020</b> , 147, 109631	3.9	5
102	Interplay of Wettability, Interfacial Reaction and Interfacial Thermal Conductance in Sn-0.7Cu Solder Alloy/Substrate Couples. <i>Journal of Electronic Materials</i> , <b>2020</b> , 49, 173-187	1.9	5
101	Transient Unidirectional Solidification, Microstructure and Intermetallics in Sn-Ni Alloys. <i>Materials Research</i> , <b>2018</b> , 21,	1.5	5
100	Electrochemical Behavior of an Al-Fe-Ni Alloy Affected by Nano-Sized Intermetallic Particles. <i>Corrosion</i> , <b>2015</b> , 71, 510-522	1.8	4
99	Application of Computational Thermodynamics to the Evolution of Surface Tension and Gibbs-Thomson Coefficient during Multicomponent Aluminum Alloy Solidification. <i>Materials Science Forum</i> , <b>2016</b> , 869, 416-422	0.4	4
98	Mechanical performance and microstructure array of as-cast lead-silver and lead-bismuth alloys. <i>Journal of Power Sources</i> , <b>2014</b> , 271, 124-133	8.9	4
97	Electrochemical Impedance Spectroscopy and Potentiodynamic Polarization Studies Affected by the Microstructure Array of a Monotectic Al-Pb Alloy in a NaCl Solution. <i>Corrosion</i> , <b>2014</b> , 70, 1031-1042	1.8	4
96	Zone Refining of Tin: Optimization of Zone Length by a Genetic Algorithm. <i>Materials and Manufacturing Processes</i> , <b>2013</b> , 28, 746-752	4.1	4
95	The effect of solidification thermal variables on surface quality of Al <sub>40</sub> Cu ingots. <i>Journal of Alloys and Compounds</i> , <b>2007</b> , 428, 130-138	5.7	4
94	Study of the nature of non-metallic inclusions in samples of aluminum and silicon killed low carbon steels, collected in the refining treatment and continuous casting stages. <i>Materials Research</i> , <b>2004</b> , 7, 517-521	1.5	4
93	A influência da microestrutura da liga Pb-0,85%Sb em seu comportamento eletroquímico. <i>Revista Materia</i> , <b>2008</b> , 13, 246-257	0.8	4
92	Laser surface treatment of plasma-sprayed yttria-stabilized zirconia coatings. <i>Revista De Metalurgia</i> , <b>2005</b> , 41, 154-159	0.4	4
91	Tailoring microstructure and microhardness of Zn <sub>10</sub> wt.%Mg <sub>10</sub> (0.5wt.%Mn, 0.5wt.%Ca) alloys by solidification cooling rate. <i>Transactions of Nonferrous Metals Society of China</i> , <b>2021</b> , 31, 1031-1048	3.3	4
90	Microstructure features and mechanical/electrochemical behavior of directionally solidified Al <sub>40</sub> wt.%Cu <sub>10</sub> wt.%Ni alloy. <i>Transactions of Nonferrous Metals Society of China</i> , <b>2021</b> , 31, 1529-1549	3.3	4
89	Correlation between unsteady-state solidification thermal parameters and microstructural growth of Zn <sub>8</sub> mass% Al and Zn <sub>8</sub> mass% Al <sub>10</sub> Bi tribological alloys. <i>Journal of Thermal Analysis and Calorimetry</i> , <b>2020</b> , 139, 1741-1761	4.1	4

88	The Roles of Ni and Co in Dendritic Growth and Tensile Properties of Fe-Containing Al <sub>3</sub> Bi <sub>2</sub> Cu <sub>2</sub> Zn Scraps under Slow and Fast Solidification Cooling. <i>Advanced Engineering Materials</i> , 2100822	3.5	4
87	Dendritic Growth, Eutectic Features and Their Effects on Hardness of a Ternary Sn <sub>2</sub> Ni <sub>2</sub> Cu Solder Alloy. <i>Acta Metallurgica Sinica (English Letters)</i> , <b>2017</b> , 30, 528-540	2.5	3
86	Plate-like growth in a eutectic Bi <sub>2</sub> Ni alloy: effects of morphological microstructure evolution and Bi <sub>3</sub> Ni intermetallic phase on tensile properties. <i>Journal of Materials Research and Technology</i> , <b>2020</b> , 9, 4940-4950	5.5	3
85	Effect of Microstructure Features on the Corrosion Behavior of the Sn-2.1 wt%Mg Solder Alloy. <i>Electronic Materials Letters</i> , <b>2020</b> , 16, 276-292	2.9	3
84	Dendritic Spacing/Columnar Grain Diameter of Al <sub>2</sub> Mg <sub>2</sub> Zn Alloys Affecting Hardness, Tensile Properties, and Dry Sliding Wear in the As-Cast/Heat-Treated Conditions. <i>Advanced Engineering Materials</i> , <b>2020</b> , 22, 1901145	3.5	3
83	Tailoring Morphology and Size of Microstructure and Tensile Properties of Sn-5.5 wt.%Sb-1 wt.%(Cu,Ag) Solder Alloys. <i>Journal of Electronic Materials</i> , <b>2018</b> , 47, 1647-1657	1.9	3
82	Dependence of Surface Tension and Viscosity on Temperature in Multicomponent Alloys <b>2019</b> ,		3
81	SEM Characterization of Al <sub>3</sub> Ni Intermetallics and its Influence on Mechanical Properties of Directionally Solidified Hypoeutectic Al-Ni Alloys. <i>Materials Science Forum</i> , <b>2010</b> , 636-637, 465-470	0.4	3
80	Numerical and experimental analysis of rapidly solidified laser remelted Al 5wt pct Ni surfaces. <i>International Journal of Microstructure and Materials Properties</i> , <b>2010</b> , 5, 193	0.4	3
79	Thermal stress analysis of a directionally solidified Al <sub>2</sub> wt%Ni alloy casting. <i>Finite Elements in Analysis and Design</i> , <b>2010</b> , 46, 889-895	2.2	3
78	Numerical and experimental analysis of laser surface remelting of Al <sub>2</sub> 5Cu alloy samples. <i>Surface Engineering</i> , <b>2005</b> , 21, 473-479	2.6	3
77	An analytical solution of directional solidification with mushy zone. <i>Archiv Für Das Eisenhüttenwesen</i> , <b>1982</b> , 53, 469-473		3
76	The Use of Empirical, Analytical, and Numerical Models to Describe Solidification of Steel During Continuous Casting. <i>Journal of Metals</i> , <b>1982</b> , 34, 34-39		3
75	Microstructure, phase morphology, eutectic coupled zone and hardness of Al Co alloys. <i>Materials Characterization</i> , <b>2020</b> , 169, 110617	3.9	3
74	Corrosion behavior of an Al <sub>2</sub> Sn <sub>2</sub> Zn alloy: Effects of solidification microstructure characteristics. <i>Journal of Materials Research and Technology</i> , <b>2021</b> , 12, 257-263	5.5	3
73	Relationship between Microstructure Evolution and Tensile Properties of AlSi10Mg Alloys with Varying Mg Content and Solidification Cooling Rates. <i>Metals</i> , <b>2021</b> , 11, 1019	2.3	3
72	Wetting behavior of Sn <sub>2</sub> Ag <sub>2</sub> Cu and Sn <sub>2</sub> Bi <sub>2</sub> X alloys: insights into factors affecting cooling rate. <i>Journal of Materials Research and Technology</i> , <b>2019</b> , 8, 1581-1586	5.5	3
71	Effect of cooling rate on microstructure and microhardness of hypereutectic Al <sub>2</sub> Ni alloy. <i>Archives of Civil and Mechanical Engineering</i> , <b>2021</b> , 21, 1	3.4	3

70	Microstructure characterization and tensile properties of directionally solidified Sn-52 wt% Bi-1wt% Sb and Sn-52wt% Bi-2wt% Sb alloys. <i>Materials Characterization</i> , <b>2020</b> , 166, 110445	3.9	2
69	High Cooling Rate, Regular and Plate Like Cells in Sn-Ni Solder Alloys. <i>Advanced Engineering Materials</i> , <b>2018</b> , 20, 1701179	3.5	2
68	Modeling the Transport of Hazardous Colloidal Suspensions of Nanoparticles Within Soil of Landfill Layers Considering Multicomponent Interactions. <i>Journal of Sustainable Metallurgy</i> , <b>2019</b> , 5, 581-593	2.7	2
67	Growth of tertiary dendritic arms during the transient directional solidification of hypoeutectic Pb-Bi alloys. <i>Philosophical Magazine</i> , <b>2011</b> , 91, 4474-4485	1.6	2
66	The Application of Computational Thermodynamics for the Determination of Surface Tension and Gibbs-Thomson Coefficient of Aluminum Ternary Alloys. <i>Materials Science Forum</i> , <b>2012</b> , 730-732, 871-876	0.4	2
65	Influence of Metal/Mold Heat Transfer Coefficient on the Inverse Macrosegregation Profile of an Al - 6.2wt% Cu Alloy Unidirectionally Solidified. <i>Materials Science Forum</i> , <b>2004</b> , 455-456, 728-731	0.4	2
64	Dendritic Spacing and Macrosegregation Affecting Microhardness of an Al-Si-Mg Alloy Solidified Under Unsteady State Conditions. <i>Materials Research</i> , <b>2019</b> , 22,	1.5	2
63	Application of a Phase Field Model to Multicomponent Al-Cu-Si alloys. <i>Materials Research</i> , <b>2020</b> , 23,	1.5	2
62	Correlação entre propriedades mecânicas e arranjo dendrítico de ligas Sn-Zn utilizadas em solda sem presença de chumbo. <i>Revista Materia</i> , <b>2009</b> , 14, 767-776	0.8	2
61	Influences of alloying elements and dendritic spacing on the corrosion behavior of Al-Bi-Ag alloys. <i>Journal of Materials Research and Technology</i> , <b>2021</b> , 15, 5880-5893	5.5	2
60	Effects of cooling rate and microstructure scale on wear resistance of unidirectionally solidified Al-3.2wt.%Bi-(1; 3) wt.%Pb alloys. <i>Materials Today Communications</i> , <b>2020</b> , 25, 101659	2.5	2
59	Purification of naphthalene by zone refining: Mathematical modelling and optimization by swarm intelligence-based techniques. <i>Separation and Purification Technology</i> , <b>2020</b> , 234, 116089	8.3	2
58	Transition from high cooling rate cells to dendrites in directionally solidified Al-Sn-(Pb) alloys. <i>Materials Today Communications</i> , <b>2020</b> , 25, 101490	2.5	2
57	Effects of Silver Content and Cooling Rate on Electrical Conductivity and Tensile Properties of Al-Si-(Ag) Alloys. <i>Journal of Materials Engineering and Performance</i> , <b>2020</b> , 29, 6849-6860	1.6	2
56	Morphology of Intermetallics Tailoring Tensile Properties and Quality Index of a Eutectic Al-Bi-Ni Alloy. <i>Advanced Engineering Materials</i> , <b>2020</b> , 22, 2000503	3.5	2
55	Interface evaluation of a Bi-Zn eutectic solder alloy: Effects of different substrate materials on thermal contact conductance. <i>International Journal of Thermal Sciences</i> , <b>2021</b> , 160, 106685	4.1	2
54	Ag-containing aluminum-silicon alloys as an alternative for as-cast components of electric vehicles. <i>Materials Research Express</i> , <b>2021</b> , 8, 016527	1.7	2
53	Multiple linear regression approach to predict tensile properties of Sn-Ag-Cu (SAC) alloys. <i>Materials Letters</i> , <b>2021</b> , 304, 130587	3.3	2

52	Dendritic and eutectic growth of Sn-0.5 wt.%Cu solders with low alloying Al levels. <i>Proceedings of the Institution of Mechanical Engineers, Part L: Journal of Materials: Design and Applications</i> , <b>2019</b> , 233, 1733-1737	1.3	1
51	Sn-Bi(-Ga) TIM Alloys: Microstructure, Tensile Properties, Wettability and Interfacial Reactions. <i>Journal of Electronic Materials</i> , <b>2019</b> , 48, 4773-4788	1.9	1
50	Microstructure and Mechanical Properties of Directionally Solidified Unmodified and Ni-Modified Sn-0.7wt%Cu Lead-Free Solder Alloy. <i>Defect and Diffusion Forum</i> , <b>2013</b> , 333, 107-115	0.7	1
49	Cellular Microstructure and Mechanical Properties of a Directionally Solidified Al-1.0wt%Fe Alloy. <i>Materials Science Forum</i> , <b>2010</b> , 636-637, 564-570	0.4	1
48	Microstructural Evolution during the Directional Transient Solidification of a Hypomonotectic Al-0.9wt%Pb Alloy. <i>Materials Science Forum</i> , <b>2012</b> , 730-732, 829-834	0.4	1
47	Heat Transfer Characteristics of Inward, Outward and Upward Solidification of an Al-1.5wt%Fe Alloy in Cylindrical Chill Molds. <i>Materials Science Forum</i> , <b>2012</b> , 730-732, 805-810	0.4	1
46	Effect of Mold Surface Roughness on the Interfacial Heat Transfer Coefficient During Solidification of Solder Alloys. <i>Materials Science Forum</i> , <b>2012</b> , 730-732, 751-756	0.4	1
45	Thermal Parameters, Microstructure and Porosity During Transient Solidification of Ternary Al-Cu-Si Alloys. <i>Materials Science Forum</i> , <b>2012</b> , 730-732, 883-888	0.4	1
44	Corrosion Resistances of As-Cast and Quenched Samples of a Zn-22Al Eutectoid Alloy. <i>Materials Science Forum</i> , <b>2008</b> , 587-588, 355-359	0.4	1
43	A influência da macrosegregação e da variação dos espaçamentos dendríticos na resistência à corrosão da liga Al-4,5%Cu. <i>Revista Materia</i> , <b>2008</b> , 13, 542-552	0.8	1
42	Experimental investigation of factors affecting surface quality of Al-Cu alloys ingots. <i>Materials Science &amp; Engineering A: Structural Materials: Properties, Microstructure and Processing</i> , <b>2006</b> , 431, 201-205	5.3	1
41	Modelagem física do sistema de alimentação do processo Twin Roll para lingotamento contínuo de tiras de aço inoxidável. <i>Revista Escola De Minas</i> , <b>2002</b> , 55, 179-184		1
40	The Application of a Mathematical Model to Analyse Ingot Thermal Behaviour During Continuous Casting. <i>IFAC Postprint Volumes IPPV / International Federation of Automatic Control</i> , <b>1983</b> , 16, 273-279		1
39	Investigation on machinability in turning of as-cast and T6 heat-treated Al-(3, 7, 12%)Si-0.6%Mg alloys. <i>Journal of Manufacturing Processes</i> , <b>2022</b> , 75, 514-526	5	1
38	Investigação de inclusões não metálicas em fios elétricos de alumínio. <i>Revista Escola De Minas</i> , <b>2002</b> , 55, 97-101		1
37	Modifications on solidification thermal parameters, microstructure and hardness induced by Cu additions to a hypereutectic Zn 8Al alloy. <i>Materials Characterization</i> , <b>2021</b> , 174, 110936	3.9	1
36	Thermal conductance at Sn-0.5mass%Al solder alloy/substrate interface as a factor for tailoring cellular/dendritic growth. <i>Journal of Thermal Analysis and Calorimetry</i> , 1	4.1	1
35	Mechanical Properties, Microstructural Features, and Correlations with Solidification Rates of Al-Cu-Si Ultrafine Eutectic Alloys. <i>Advanced Engineering Materials</i> , <b>2021</b> , 23, 2001177	3.5	1



34	Evaluating Microstructure, Wear Resistance and Tensile Properties of Al-Bi(-Cu, -Zn) Alloys for Lightweight Sliding Bearings. <i>Metals</i> , <b>2021</b> , 11, 153	2.3	1
33	On the Transient Atomic/Heat Diffusion in Cylinders and Spheres with Phase Change: A Method to Derive Closed-Form Solutions. <i>International Journal of Mathematics and Mathematical Sciences</i> , <b>2021</b> , 2021, 1-19	0.8	1
32	Microstructural and segregation effects affecting the corrosion behavior of a high-temperature Bi-Ag solder alloy in dilute chloride solution. <i>Journal of Applied Electrochemistry</i> , <b>2021</b> , 51, 769-780	2.6	1
31	On the Determination of Molar Heat Capacity of Transition Elements: From the Absolute Zero to the Melting Point		1
30	Towards a morphological control of Mg <sub>2</sub> Si and superior tensile properties of high-Zn Mg-0.6Si (-Zn) alloys. <i>Materials Letters</i> , <b>2021</b> , 299, 130084	3.3	1
29	Numerical Simulation and Experimental Analysis of Laser Surface Remelting of AISI 304 Stainless Steel Samples. <i>Materials Science Forum</i> , <b>2010</b> , 636-637, 1119-1124	0.4	0
28	Numerical and Experimental Analysis of Laser Surface Remelting of Al 9wt% Si Alloy Samples. <i>Materials Science Forum</i> , <b>2008</b> , 587-588, 721-725	0.4	0
27	Efeitos da agitação mecânica e de adição de refinador de grão na microestrutura e propriedade mecânica de fundidos da liga Al-Sn. <i>Revista Materia</i> , <b>2009</b> , 14, 906-917	0.8	0
26	Two-Phase Dendrite and Bimodal Structure in an Al-Cu-Ni Alloy: Their Roles in Hardness. <i>Journal of Materials Engineering and Performance</i> , 1	1.6	0
25	Closed-form solution for the inward unsteady-state solidification of cylinders and spheres: pure metals and eutectics. <i>Journal of Thermal Analysis and Calorimetry</i> , 1	4.1	0
24	The Effects of Solidification Cooling and Growth Rates on Microstructure and Hardness of Supersaturated Al-7%Si-x%Zn Alloys. <i>Journal of Materials Engineering and Performance</i> , 1	1.6	0
23	Microstructure, Hardness, Tensile Strength, and Sliding Wear of Hypoeutectic Al <sub>85</sub> Bi Cast Alloys with Small Cr Additions and Fe-Impurity Content. <i>Advanced Engineering Materials</i> , 2001552	3.5	0
22	Solidification microstructure-dependent hydrogen generation behavior of Al <sub>85</sub> Sn and Al <sub>85</sub> Fe alloys in alkaline medium. <i>International Journal of Hydrogen Energy</i> , <b>2021</b> , 46, 12654-12671	6.7	0
21	Interfacial heat transfer and microstructural analyses of a Bi- 5% Sb lead-free alloy solidified against Cu, Ni and low-C steel substrates. <i>Journal of Alloys and Compounds</i> , <b>2021</b> , 860, 158553	5.7	0
20	Effect of Bi content on microstructure and corrosion behaviour of Zn <sub>85</sub> Al <sub>15</sub> (Bi) alloys. <i>Corrosion Engineering Science and Technology</i> , <b>2021</b> , 56, 461-472	1.7	0
19	Sn-Mg lead-free solder alloy: Effect of solidification thermal parameters on microstructural features and microhardness. <i>Materials Research Express</i> , <b>2019</b> , 6, 126562	1.7	0
18	Electrochemical corrosion behaviour of Sn <sub>85</sub> Sb solder alloys: the roles of alloy Sb content and type of intermetallic compound. <i>Corrosion Engineering Science and Technology</i> , <b>2021</b> , 56, 11-21	1.7	0
17	Metal/mold thermal conductance affecting ultrafine scale microstructures in aluminum eutectic alloys. <i>Case Studies in Thermal Engineering</i> , <b>2021</b> , 26, 101144	5.6	0



16	Tailoring microstructure and tensile properties of Mg-Si alloys varying solidification cooling rate and Si content. <i>Materials Science &amp; Engineering A: Structural Materials: Properties, Microstructure and Processing</i> , <b>2021</b> , 825, 141905	5.3	o
15	NbB refining capability: Effects of slow and rapid solidification on dendritic spacings and grain sizes of a 6201 alloy. <i>Materials Letters</i> , <b>2022</b> , 315, 131960	3.3	o
14	Laser remelting of AlSi10Mg(-Ni) alloy surfaces: influence of Ni content and cooling rate on the microstructure. <i>International Journal of Advanced Manufacturing Technology</i> , <sup>1</sup>	3.2	o
13	Experimental and numerical analyses of laser remelted Sn-0.7 wt%Cu solder surfaces. <i>Journal of Materials Science: Materials in Electronics</i> , <b>2015</b> , 26, 3100-3107	2.1	
12	Correlation between microstructure and hardness of a Bi-1.5wt%Ag lead-free solder alloy. <i>IOP Conference Series: Materials Science and Engineering</i> , <b>2016</b> , 117, 012028	0.4	
11	Upward and downward unsteady-state directional solidification of a hypoeutectic Al-3wt.%Mg alloy. <i>Ciência &amp; Tecnologia Dos Materiais</i> , <b>2017</b> , 29, e65-e70		
10	Macrosegregation and Porosity during Directional Solidification of a Ternary Al-9wt%Si-3wt%Cu Alloy. <i>Defect and Diffusion Forum</i> , <b>2011</b> , 312-315, 405-410	0.7	
9	Assessment of Cooling Conditions of a Continuous Casting Machine for Steel Billets Based on Surface Temperature Measurements. <i>Materials Science Forum</i> , <b>2012</b> , 730-732, 841-846	0.4	
8	Unsteady-State Directional Solidification of a Hypoperitectic Pb-9.5wt%Bi Alloy. <i>Materials Science Forum</i> , <b>2012</b> , 730-732, 889-894	0.4	
7	Numerical Simulation and Experimental Analysis of Laser Surface Remelting of AISI 420 Stainless Steel Samples. <i>Advanced Materials Research</i> , <b>2008</b> , 59, 265-268	0.5	
6	Development and Experimental Validation of a Numerical Thermal Model for the Evaluation of the Depth of Laser Treated Zone in the Laser Transformation Hardening Process. <i>Materials Science Forum</i> , <b>2003</b> , 423-425, 707-712	0.4	
5	Mathematical Modelling of Fractional Solidification <b>2005</b> , 398-403		
4	Influence of Solidification Microstructure on the Wear Resistance of Al-Si and Al-Sn Alloys Directionally Solidified under Unsteady State Conditions.595-603		
3	Galvanic corrosion analysis of a Bi-20Sn solder alloy coupled to Ni and Cu substrates. <i>Corrosion Engineering Science and Technology</i> , <b>2020</b> , 55, 729-738	1.7	
2	The Roles of Ni and Co in Dendritic Growth and Tensile Properties of Fe-Containing Al-Bi-Cu-Zn Scraps under Slow and Fast Solidification Cooling. <i>Advanced Engineering Materials</i> , <b>2022</b> , 24, 2270013	3.5	
1	Nature inspired algorithms for the solution of inverse heat transfer problems applied to distinct unsteady heat flux orientations in cylindrical castings. <i>Journal of Intelligent Manufacturing</i> , <sup>1</sup>	6.7	